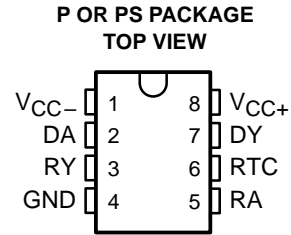


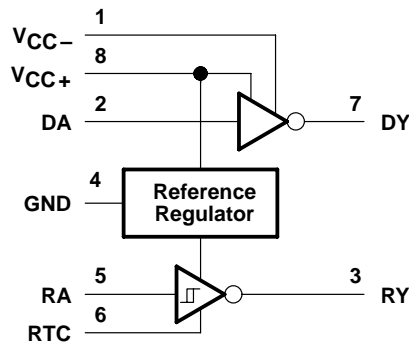
- Meets or Exceeds the Requirements of ANSI TIA/EIA-232-C
- Wide Range of Supply Voltage
 $V_{CC} = \pm 4.5 \text{ V to } \pm 15 \text{ V}$
- Low Power . . . 117 mW ($V_{CC} = \pm 9 \text{ V}$)
- Receiver Output TTL Compatible
- Response Control Provides:
 - Input Threshold Shifting
 - Input Noise Filtering



description

The SN751701 line driver and receiver is designed to satisfy the requirements of the standard interface between data terminal equipment and data communication equipment as defined by ANSI TIA/EIA-232-E. The driver used is similar to the SN75188. The receiver used is similar to the SN75189A. The device operates over a wide range of supply voltages ($V_{CC} = \pm 4.5 \text{ V to } \pm 15 \text{ V}$) from the included reference regulator.

logic diagram

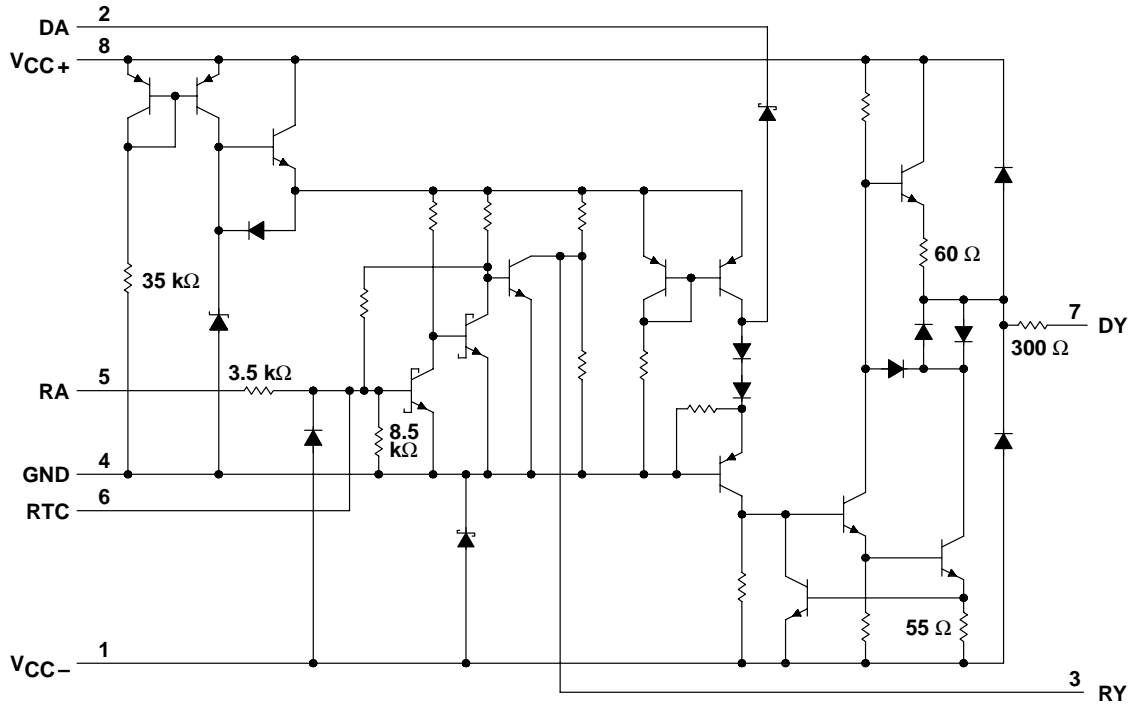


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SN751701 LINE DRIVER AND RECEIVER

SLLS531 – MARCH 2002

schematic



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|--|------------------------------|
| Supply voltage range, V_{CC+} (see Note 1) | −0.4 V to 18 V |
| Supply voltage range, V_{CC-} (see Note 1) | 0.4 V to −18 V |
| Input voltage range, V_I : Driver | −5 V to 18 V |
| Receiver | −30 V to 30 V |
| Output voltage range, V_O : Driver | −25 V to 25 V |
| Receiver | −0.4 V to 7 V |
| Output current, I_O (D) Driver | 50 mA |
| Response control current range, I_{RES} | −10 mA to 10 mA |
| Continuous total power dissipation | See Dissipation Rating Table |
| Package thermal impedance, θ_{JA} (see Note 2): P package | 85°C/W |
| PS package | 95°C/W |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | 260°C |
| Storage temperature range, T_{stg} | −65°C to 150°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values are with respect to the network ground terminal.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

| | | MIN | MAX | UNIT | |
|-------------------|--------------------------------|------------|-----|------|----|
| V _{CC+} | Supply voltage | 4.5 | 15 | V | |
| V _{CC-} | Supply voltage | -4.5 | -15 | V | |
| V _{I(D)} | Input voltage, driver | | 15 | V | |
| V _{I(R)} | Input voltage, receiver | -25 | 25 | V | |
| I _{RESP} | Response control current | -5.5 | 5.5 | mA | |
| I _{O(R)} | Output current, receiver | | 24 | mA | |
| T _A | Operating free-air temperature | P package | -20 | 85 | °C |
| | | PS package | -20 | 70 | |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

total device

| PARAMETER | TEST CONDITIONS | | MIN | TYP† | MAX | UNIT |
|---|-------------------------|---|-----|-------|-------|------|
| I _{CCH+} High-level supply current | V _{CC} = ±5 V | V _{I(D)} = 2 V, V _{I(R)} = V _{T+(max)} , Output open | | 6.3 | 8.1 | mA |
| | V _{CC} = ±9 V | | | 9.1 | 11.9 | |
| | V _{CC} = ±12 V | | | 10.4 | 14 | |
| I _{CCL+} Low-level supply current | V _{CC} = ±5 V | V _{I(D)} = 0.8 V, V _{I(R)} = V _{T-(min)} , Output open | | 2.5 | 3.4 | mA |
| | V _{CC} = ±9 V | | | 3.7 | 5.1 | |
| | V _{CC} = ±12 V | | | 4.1 | 5.6 | |
| I _{CCH-} High-level supply current | V _{CC} = ±5 V | V _{I(D)} = 2 V, V _{I(R)} = V _{T+(max)} , Output open | | -2.4 | -3.1 | mA |
| | V _{CC} = ±9 V | | | -3.9 | -4.9 | |
| | V _{CC} = ±12 V | | | -4.8 | -6.1 | |
| I _{CCL-} Low-level supply current | V _{CC} = ±5 V | V _{I(D)} = 0.8 V, V _{I(R)} = V _{T-(min)} , Output open | | -0.2 | -0.35 | mA |
| | V _{CC} = ±9 V | | | -0.25 | -0.4 | |
| | V _{CC} = ±12 V | | | -0.27 | -0.45 | |
| I _{CC+} Positive supply current | V _{CC} = ±5 V | V _{I(R)} = V _{T+(max)} , V _{I(D)} = 0 V, V _{CC-} = 0 V, Output open | | 4.8 | 6.4 | mA |
| | V _{CC} = ±12 V | | | 6.7 | 9.1 | |

† All typical values are at T_A = 25°C.

SN751701 LINE DRIVER AND RECEIVER

SLLS531 – MARCH 2002

electrical characteristics over recommended operating free-air temperature range, $V_{CC+} = 12\text{ V}$, $V_{CC-} = -12\text{ V}$ (unless otherwise noted)

driver section

| PARAMETER | | TEST CONDITIONS | MIN | TYP† | MAX | UNIT |
|-------------|---|---|----------------------------|------|-------|---------------|
| V_{IH} | High-level input voltage | | 2 | | | V |
| V_{IL} | Low-level input voltage | | | | 0.8 | V |
| V_{OH} | High-level output voltage | $V_{I(D)} = 0.8\text{ V}$, $R_L = 3\text{ k}\Omega$ | $V_{CC} = \pm 5\text{ V}$ | 3.2 | 3.7 | V |
| | | | $V_{CC} = \pm 9\text{ V}$ | 6.5 | 7.2 | |
| | | | $V_{CC} = \pm 12\text{ V}$ | 8.9 | 9.8 | |
| V_{OL} | Low-level output voltage | $V_{I(D)} = 2\text{ V}$, $R_L = 3\text{ k}\Omega$ | $V_{CC} = \pm 5\text{ V}$ | -3.6 | -3.2 | V |
| | | | $V_{CC} = \pm 9\text{ V}$ | -7.1 | -6.4 | |
| | | | $V_{CC} = \pm 12\text{ V}$ | -9.7 | -8.8 | |
| I_{IH} | High-level input current | $V_{I(D)} = 7\text{ V}$ | | | 5 | μA |
| I_{IL} | Low-level input current | $V_{I(D)} = 0\text{ V}$ | -0.73 | -1.2 | | mA |
| $I_{OS(H)}$ | High-level short-circuit output current | $V_{I(D)} = 0.8\text{ V}$, $V_{O(D)} = 0\text{ V}$ | -7 | -12 | -14.5 | mA |
| $I_{OS(L)}$ | Low-level short-circuit output current | $V_{I(D)} = 2\text{ V}$, $V_{O(D)} = 0\text{ V}$ | 6.5 | 11.5 | 14 | mA |
| r_O | Output resistance | $V_{CC+} = 0\text{ V}$, $V_{O(D)} = -2\text{ V}$ to 2 V | 300 | | | Ω |

† All typical values are at $T_A = 25^\circ\text{C}$.

switching characteristics, $V_{CC+} = 12\text{ V}$, $V_{CC-} = -12\text{ V}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

driver section (see Figure 2)

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------|---|--|-----|-----|-----|---------------|
| t_{PLH} | Propagation delay time, low- to high-level output | $R_L = 3\text{ k}\Omega$, $C_L = 50\text{ pF}$ | | 340 | 480 | ns |
| t_{PHL} | Propagation delay time, high- to low-level output | | | 100 | 150 | |
| t_{TLH} | Transition time, low- to high-level output | $R_L = 3\text{ k}\Omega$, $C_L = 50\text{ pF}$ | | 120 | 180 | ns |
| t_{THL} | Transition time, high- to low-level output | | | 105 | 160 | |
| t_{TLH} | Transition time, low- to high-level output | $R_L = 3\text{ k}\Omega$ to $7\text{ k}\Omega$ (see Note 3), $C_L = 2500\text{ pF}$ | | 2.1 | 3 | μs |
| t_{THL} | Transition time, high- to low-level output | | | 2.1 | 3 | |

NOTE 3: The time is measured between 3 V and -3 V on output waveform.



electrical characteristics over recommended operating free-air temperature range, $V_{CC+} = 12\text{ V}$, $V_{CC-} = -12\text{ V}$ (unless otherwise noted)

receiver section (see Figure 1) (see Note 4)

| PARAMETER | | TEST CONDITIONS | MIN | TYP† | MAX | UNIT | |
|------------|--|---|-------------------------|-------|------|------|---|
| V_{IT+} | Positive-going input threshold voltage | | 1.2 | 1.9 | 2.3 | V | |
| V_{IT-} | Negative-going input threshold voltage | | 0.6 | 0.95 | 1.2 | V | |
| V_{hys} | Hysteresis voltage ($V_{IT+} - V_{IT-}$) | | 0.6 | | | V | |
| $V_{O(H)}$ | High-level output voltage | $V_{I(R)} = V_{T-(min)}$, $I_{OL} = -10\ \mu\text{A}$ | $V_{CC+} = 5\text{ V}$ | 3.7 | 4.1 | 4.5 | V |
| | | | $V_{CC+} = 12\text{ V}$ | 4.4 | 4.7 | 5.2 | |
| | | $V_{I(R)} = V_{T-(min)}$, $I_{OH} = -0.4\text{ mA}$ | $V_{CC+} = 5\text{ V}$ | 3.1 | 3.4 | 3.8 | |
| | | | $V_{CC+} = 12\text{ V}$ | 3.6 | 4 | 4.5 | |
| $V_{O(L)}$ | Low-level output voltage | $V_{I(R)} = V_{T+(max)}$, $I_{OL} = 24\text{ mA}$ | | 0.2 | 0.3 | V | |
| I_{IH} | High-level input current | $V_{I(R)} = 25\text{ V}$ | 3.6 | 6.7 | 8.3 | mA | |
| | | $V_{I(R)} = 3\text{ V}$ | 0.43 | 0.67 | 1 | mA | |
| I_{IL} | Low-level input current | $V_{I(R)} = -25\text{ V}$ | -3.6 | -6.7 | -8.3 | mA | |
| | | $V_{I(R)} = -3\text{ V}$ | -0.43 | -0.74 | -1 | mA | |
| I_{OS} | Short-circuit output current | $V_{I(R)} = V_{T-(min)}$ | | -2.8 | -3.7 | mA | |

† All typical values are at $T_A = 25^\circ\text{C}$.

NOTE 4: Response Control pin is open.

switching characteristics, $V_{CC+} = 12\text{ V}$, $V_{CC-} = -12\text{ V}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

receiver section (see Figure 2)

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------|---|---|-----|-----|-----|------|
| t_{PLH} | Propagation delay time, low- to high-level output | $R_L = 400\text{ k}\Omega$, $C_L = 50\text{ pF}$ | | 150 | 240 | ns |
| t_{PHL} | Propagation delay time, high- to low-level output | | | 50 | 100 | |
| t_{TLH} | Transition time, low- to high-level output | $R_L = 400\text{ k}\Omega$, $C_L = 50\text{ pF}$ | | 250 | 360 | ns |
| t_{THL} | Transition time, high- to low-level output | | | 18 | 35 | |

PARAMETER MEASUREMENT INFORMATION

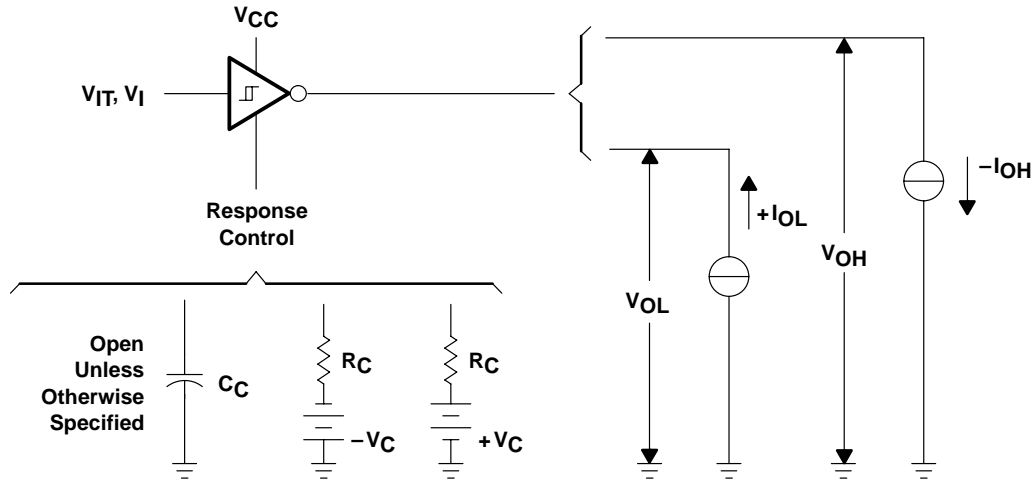
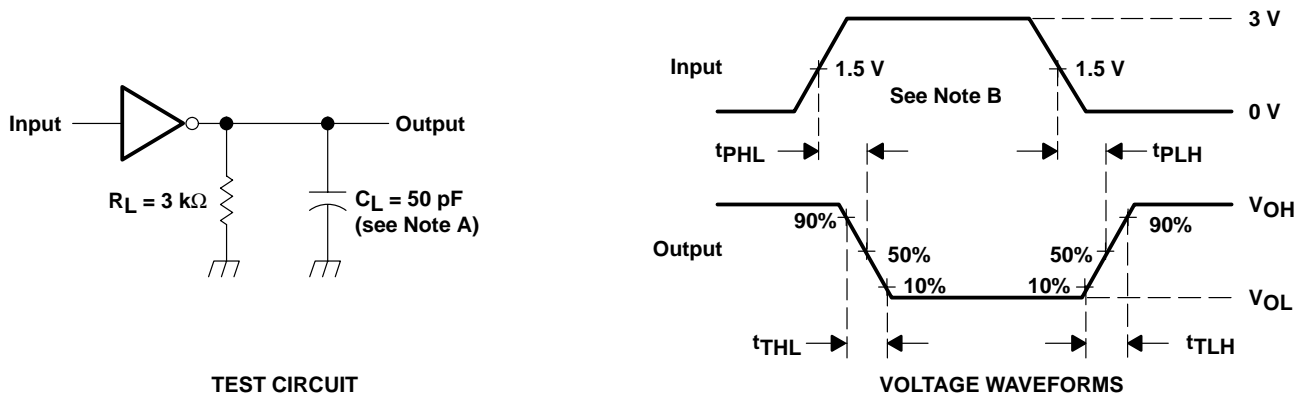


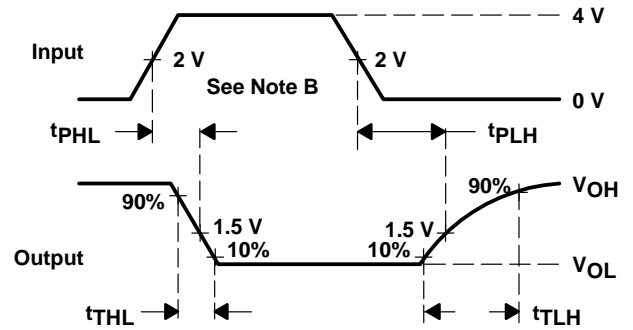
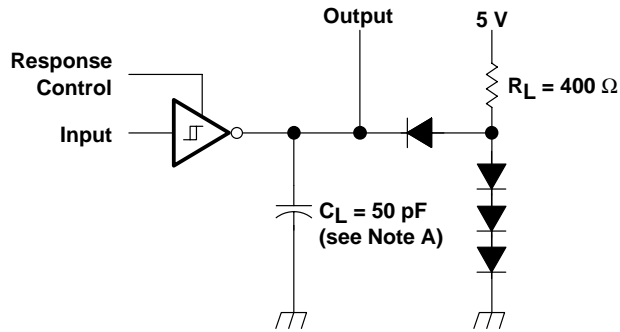
Figure 1. Receiver Section Test Circuit (V_{IT+} , V_{IT-} , V_{OH} , V_{OL})



- NOTES: A. C_L includes probe and jig capacitance.
 B. The input waveform is supplied by a generator having the following characteristics: $Z_O = 50\ \Omega$, $t_w = 500\text{ ns}$, $t_{TLH} \leq 5\text{ ns}$, $t_{THL} \leq 5\text{ ns}$.

Figure 2. Driver Section Switching Test Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT

VOLTAGE WAVEFORMS

- NOTES: A. C_L includes probe and jig capacitance.
 B. The input waveform is supplied by a generator having the following characteristics: $Z_O = 50 \Omega$, $t_w = 500 \text{ ns}$, $t_{THL} \leq 5 \text{ ns}$, $t_{TLH} \leq 5 \text{ ns}$.

Figure 3. Receiver Section Switching Test Circuit and Voltage Waveforms

TYPICAL CHARACTERISTICS

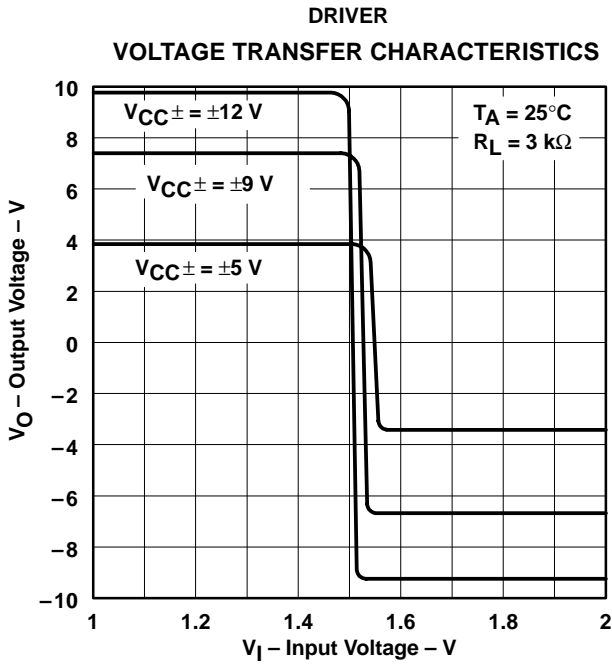


Figure 4

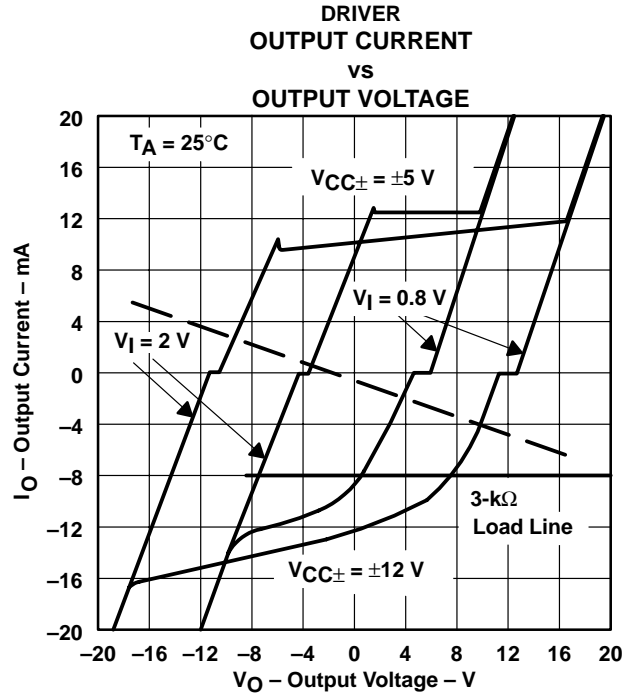


Figure 5

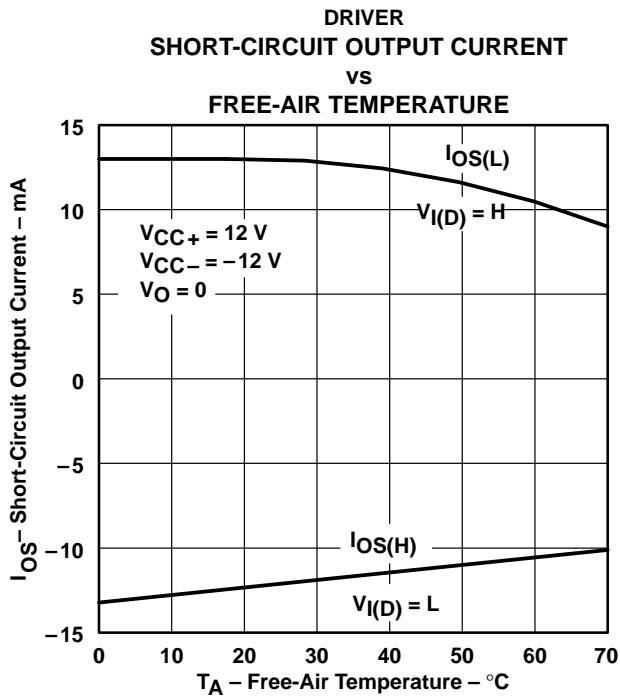


Figure 6

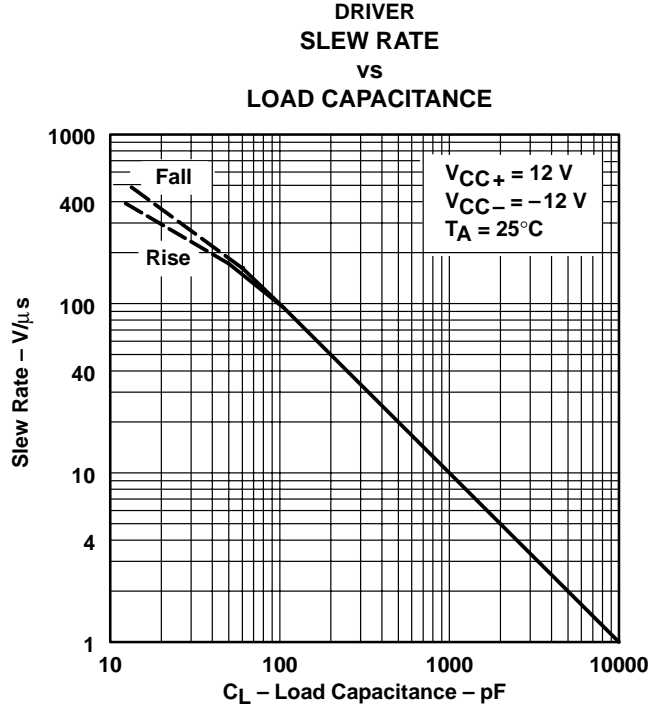


Figure 7

TYPICAL CHARACTERISTICS

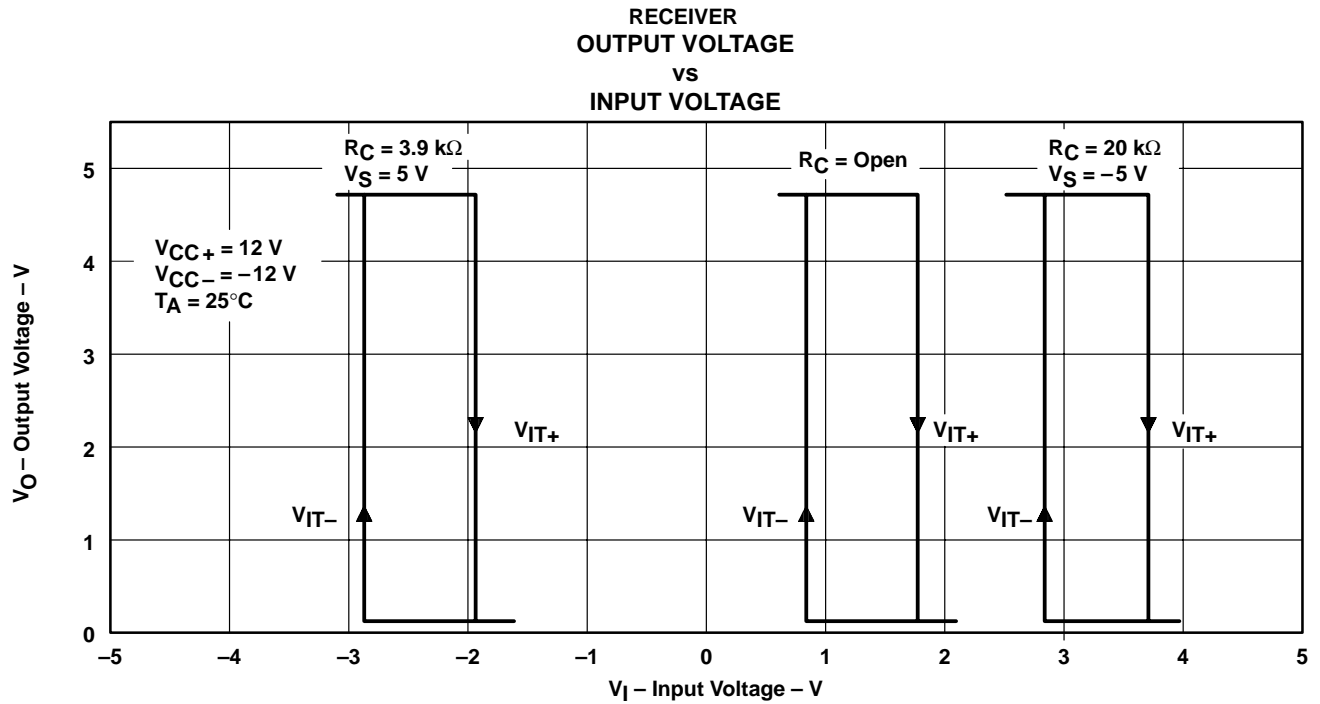


Figure 8

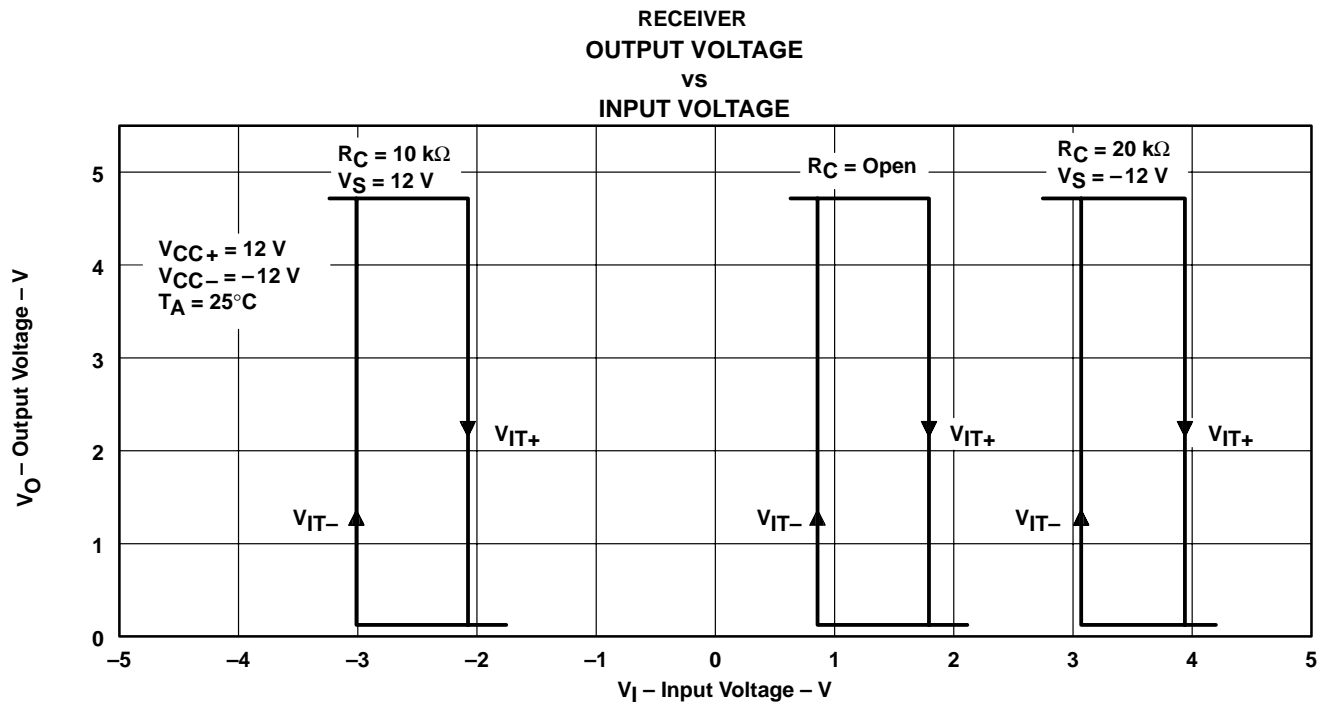
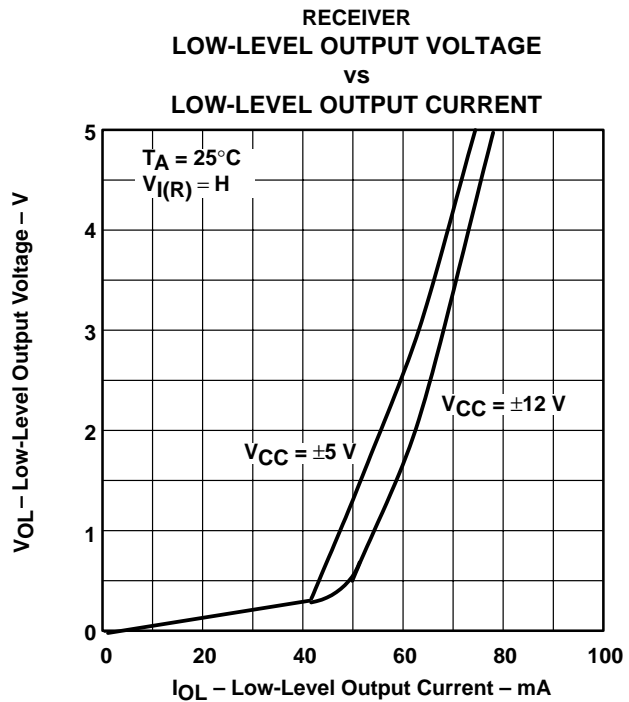
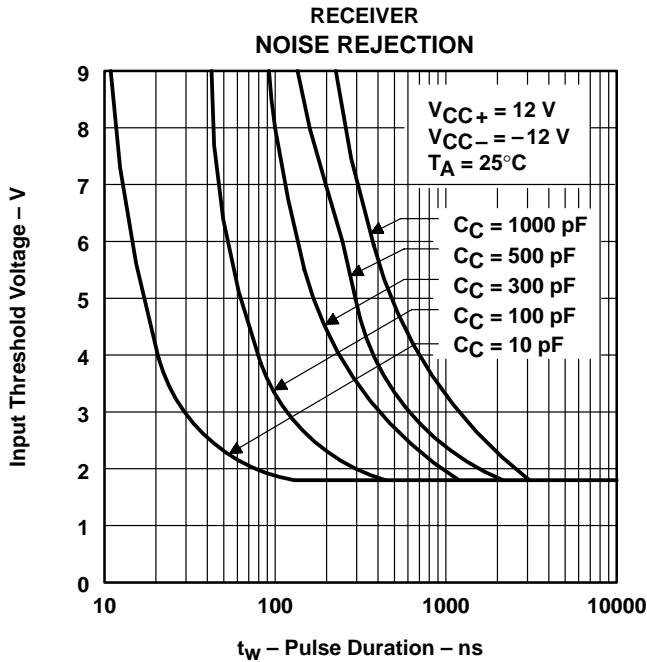
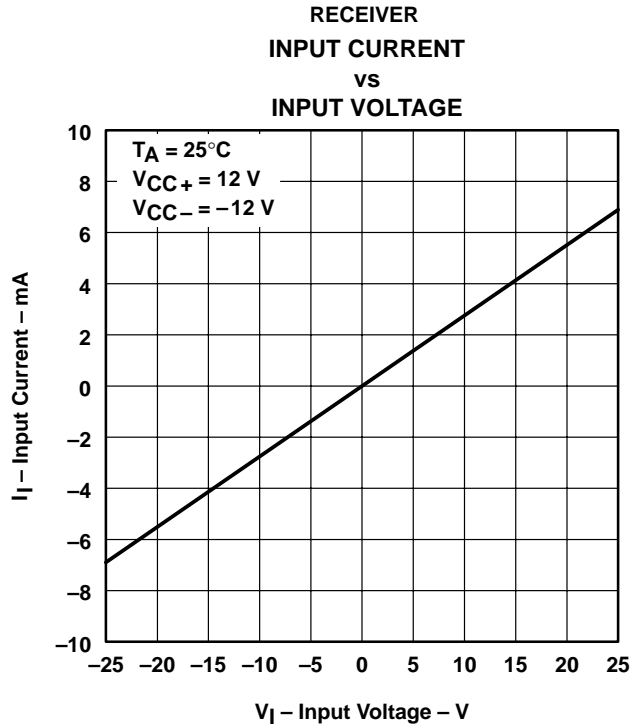
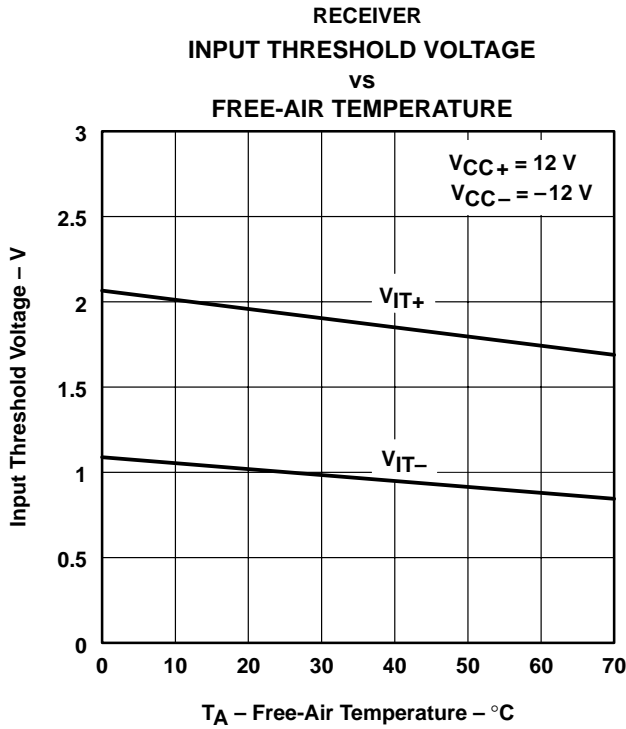


Figure 9

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

RECEIVER
HIGH-LEVEL OUTPUT VOLTAGE
vs
HIGH-LEVEL OUTPUT CURRENT

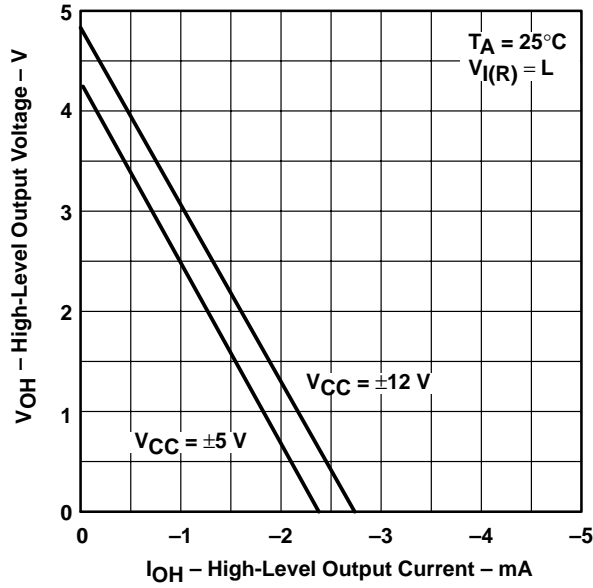


Figure 14

RECEIVER
OUTPUT VOLTAGE
vs
SUPPLY VOLTAGE

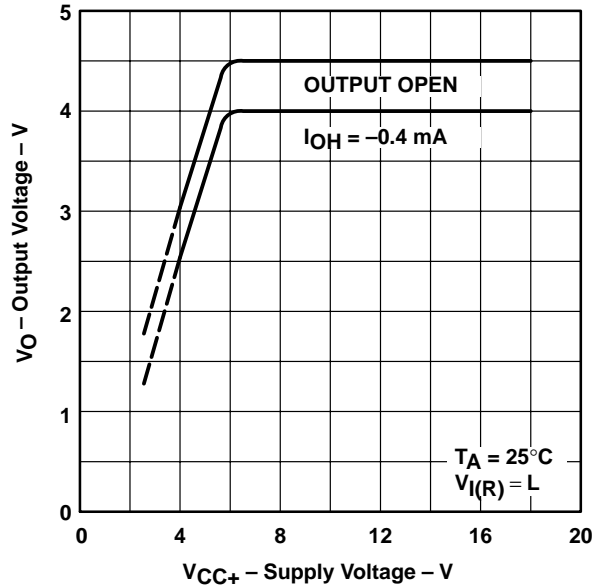


Figure 15

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|--|
| SN751701PSR | ACTIVE | SO | PS | 8 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-2-260C-1 YEAR/ Level-1-235C-UNLIM |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - May not be currently available - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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MECHANICAL DATA

PS (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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